

## SiA406DJ

Vishay Siliconix

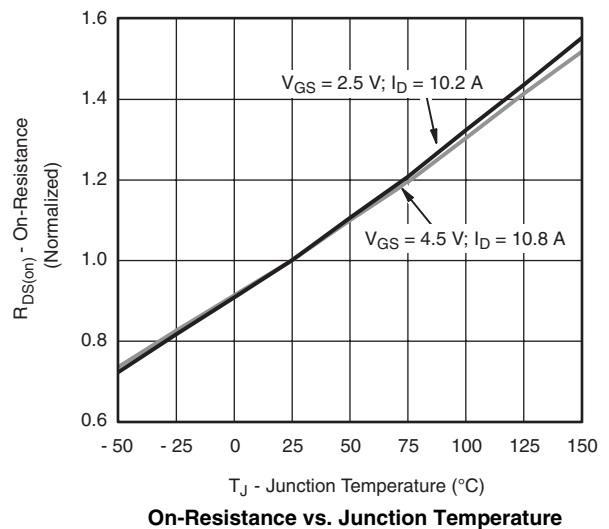
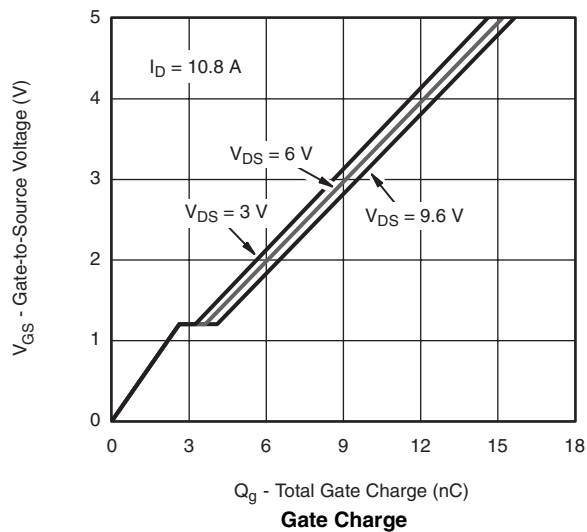
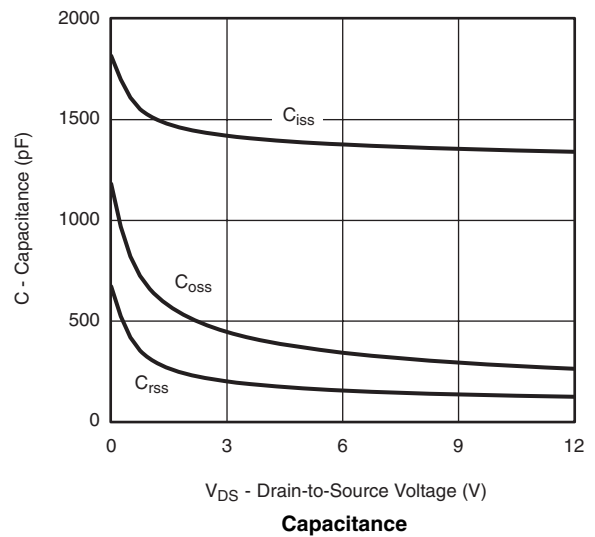
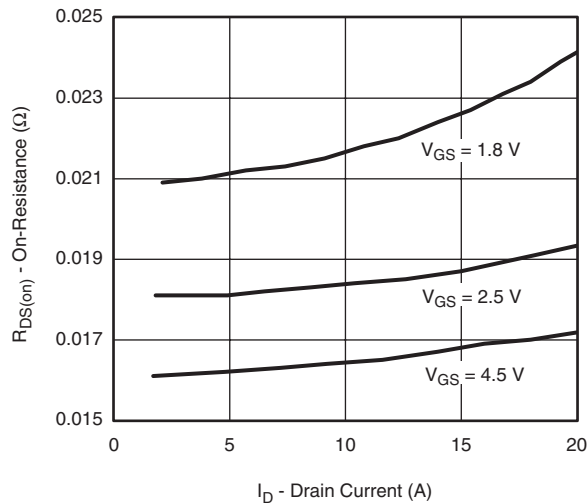
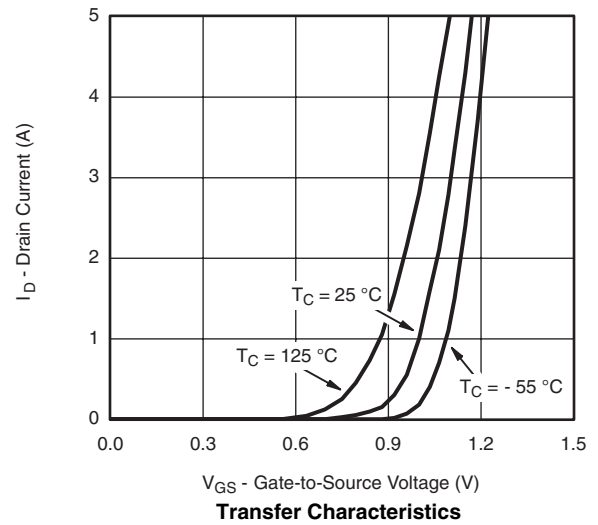
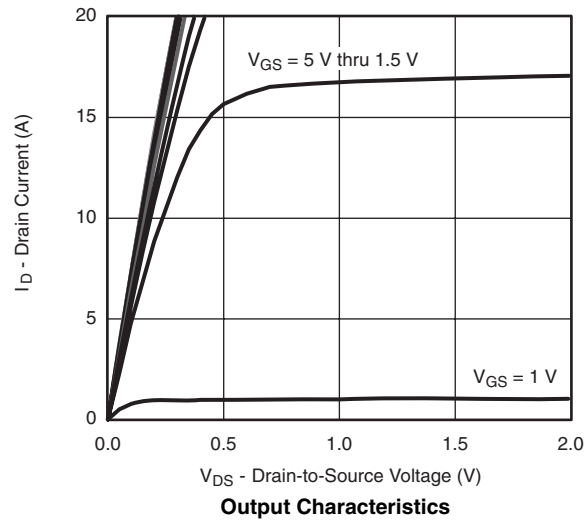


SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	12			V	
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA		11		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>			- 2.9			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	0.4		1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 8 V			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V			1	μA	
		V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≤ 5 V, V <sub>GS</sub> = 4.5 V		20		A	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10.8 A		0.0165	0.0198	Ω	
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 10.2 A		0.0185	0.0222		
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 3 A		0.0220	0.0264		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 6 V, I <sub>D</sub> = 10.8 A		38		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1380		pF	
Output Capacitance	C <sub>oss</sub>			345			
Reverse Transfer Capacitance	C <sub>rss</sub>			155			
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 10.8 A		15.2	23	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10.8 A		13.7	21		
Gate-Drain Charge	Q <sub>gd</sub>			2.6			
Gate Resistance	R <sub>g</sub>			1.1			
Turn-On Delay Time	t <sub>d(on)</sub>	f = 1 MHz	0.5	2.5	5	Ω	
Rise Time	t <sub>r</sub>		V <sub>DD</sub> = 6 V, R <sub>L</sub> = 0.7 Ω I <sub>D</sub> ≅ 8.6 A, V <sub>GEN</sub> = 4.5 V, R <sub>g</sub> = 1 Ω		10	20	ns
Turn-Off Delay Time	t <sub>d(off)</sub>				9	18	
Fall Time	t <sub>f</sub>				40	60	
Turn-On Delay Time	t <sub>d(on)</sub>			14	21		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 6 V, R <sub>L</sub> = 0.7 Ω I <sub>D</sub> ≅ 8.6 A, V <sub>GEN</sub> = 8 V, R <sub>g</sub> = 1 Ω		6	12		
Turn-Off Delay Time	t <sub>d(off)</sub>			11	17		
Fall Time	t <sub>f</sub>			27	41		
				9	18		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			4.5 <sup>c</sup>	A	
Pulse Diode Forward Current	I <sub>SM</sub>				20		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 8.6 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 8.6 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C		22	33	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			7	14	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			8		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			14			

## Notes:

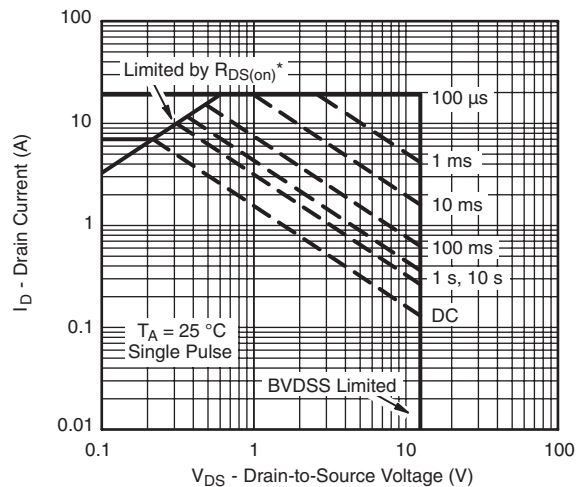
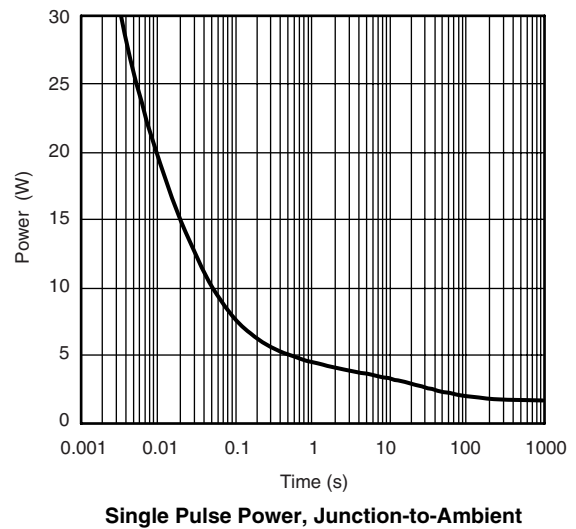
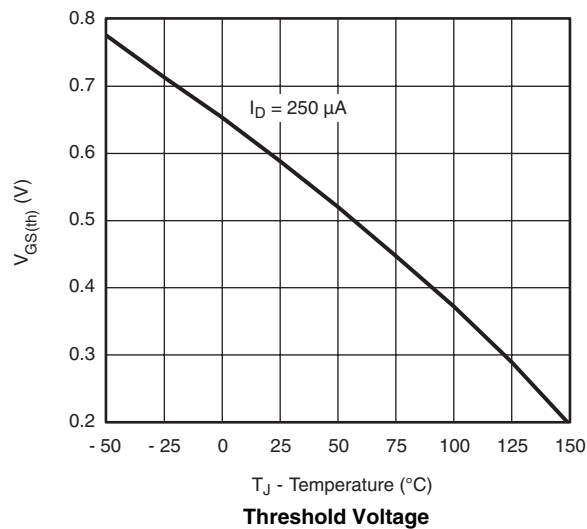
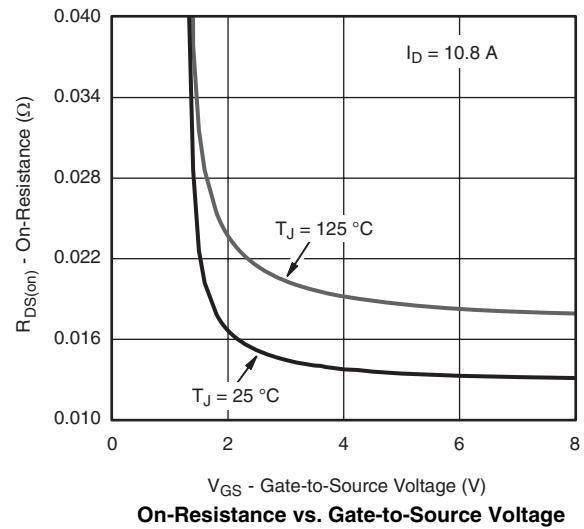
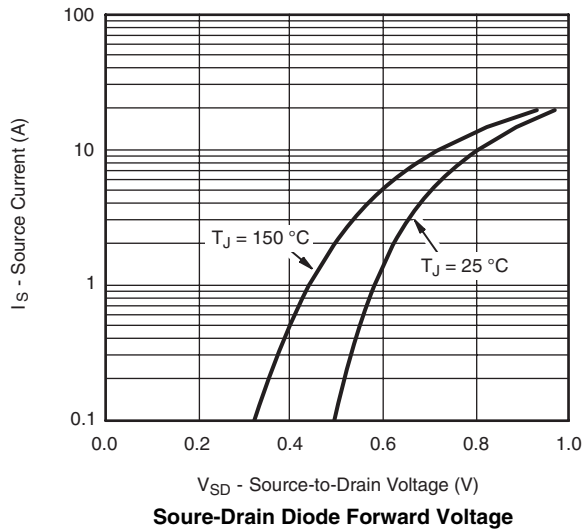
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.  
c. Package limited

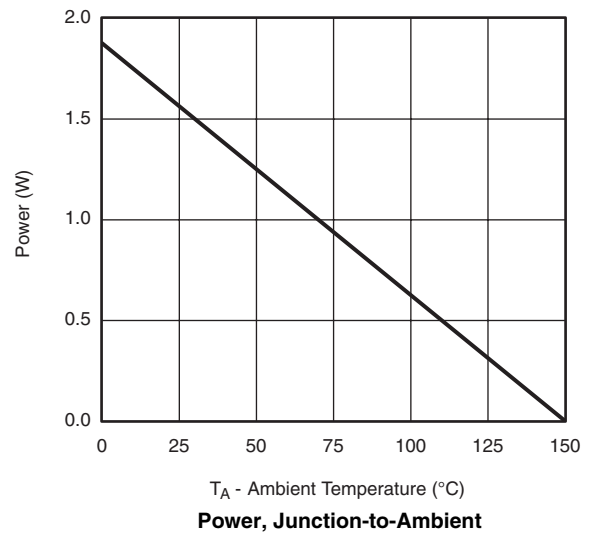
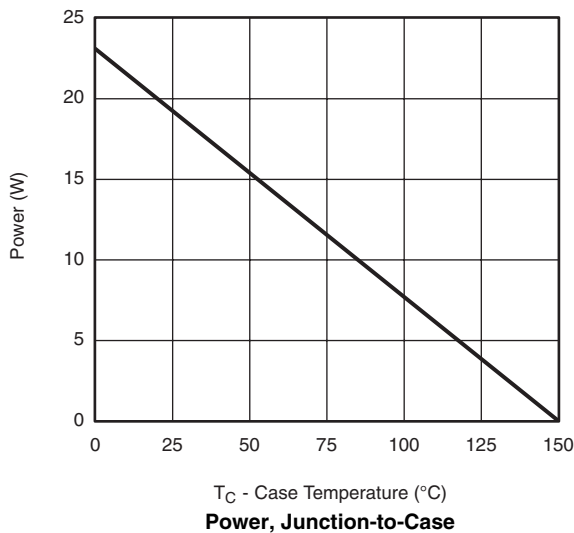
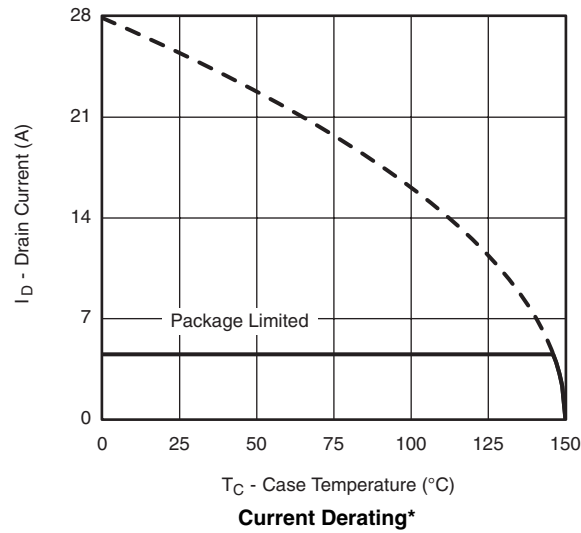
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


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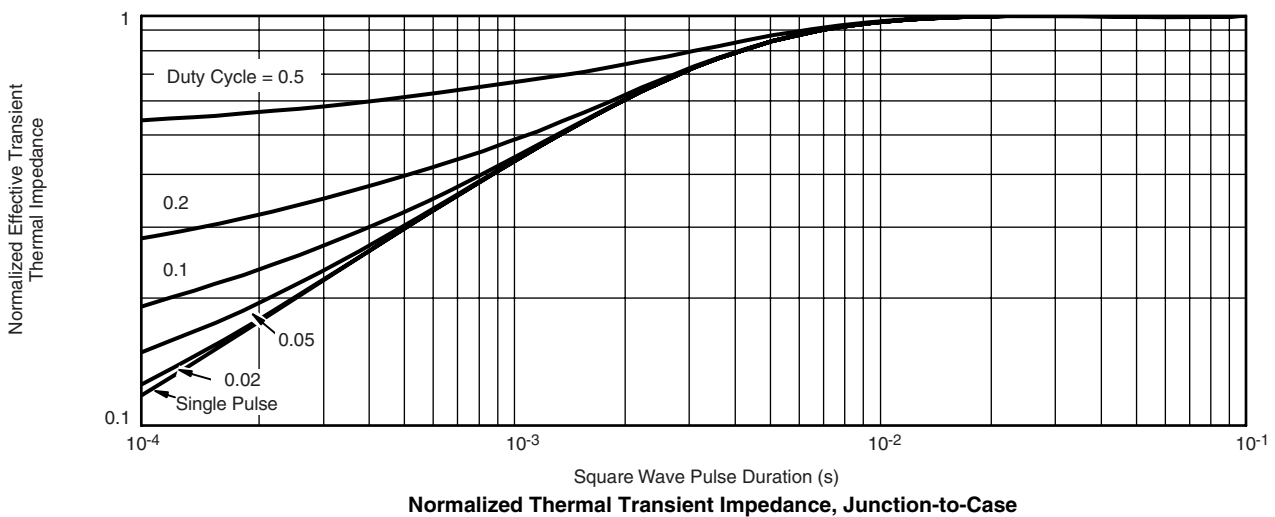
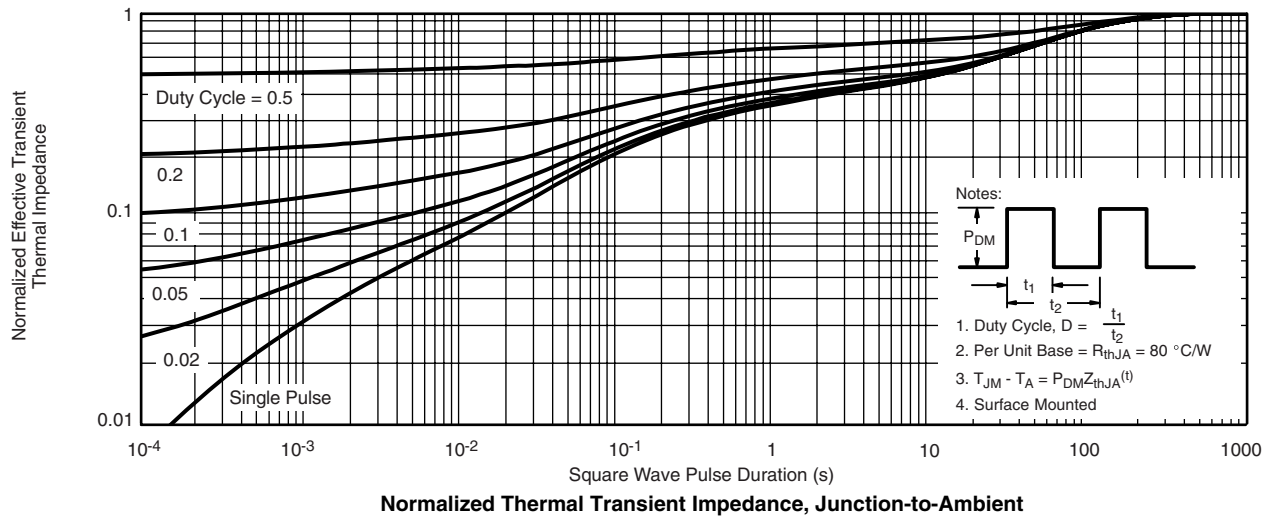
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified**Safe Operating Area, Junction-to-Ambient**


**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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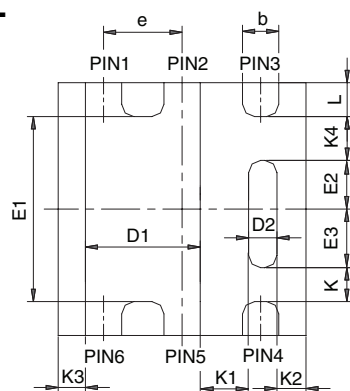
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**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

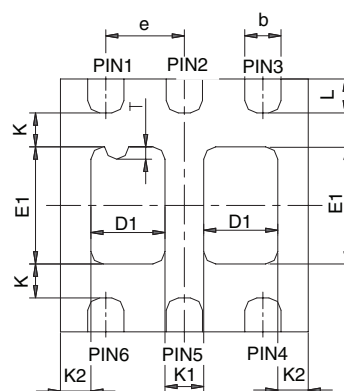
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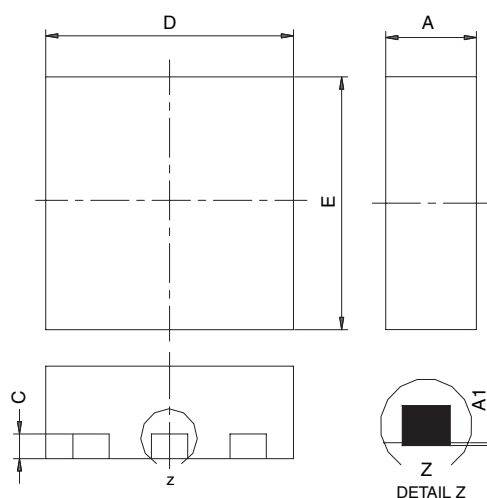
## PowerPAK® SC70-6L



BACKSIDE VIEW OF SINGLE



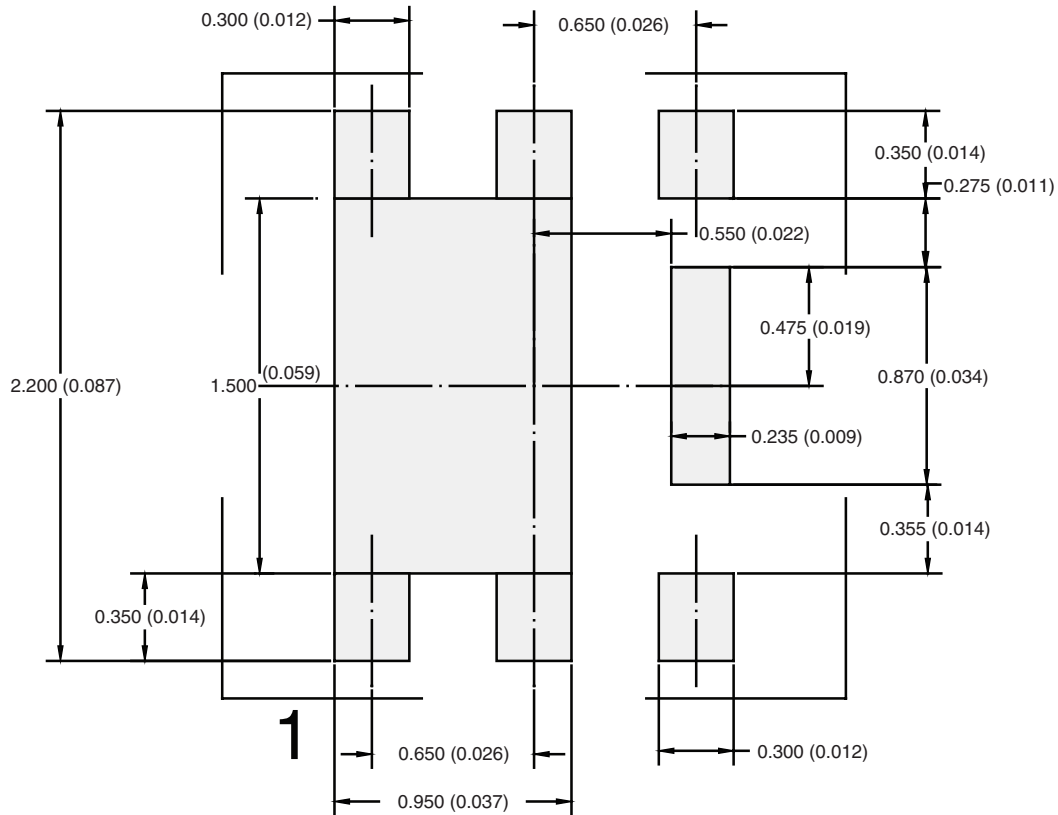
BACKSIDE VIEW OF DUAL



- Notes:
1. All dimensions are in millimeters
  2. Package outline exclusive of mold flash and metal burr
  3. Package outline inclusive of plating

DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
A	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
C	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
e	0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K	0.275 TYP			0.011 TYP			0.275 TYP			0.011 TYP		
K1	0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2	0.240 TYP			0.009 TYP			0.252 TYP			0.010 TYP		
K3	0.225 TYP			0.009 TYP								
K4	0.355 TYP			0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006
ECN: C-07431 – Rev. C, 06-Aug-07												
DWG: 5934												

## RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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